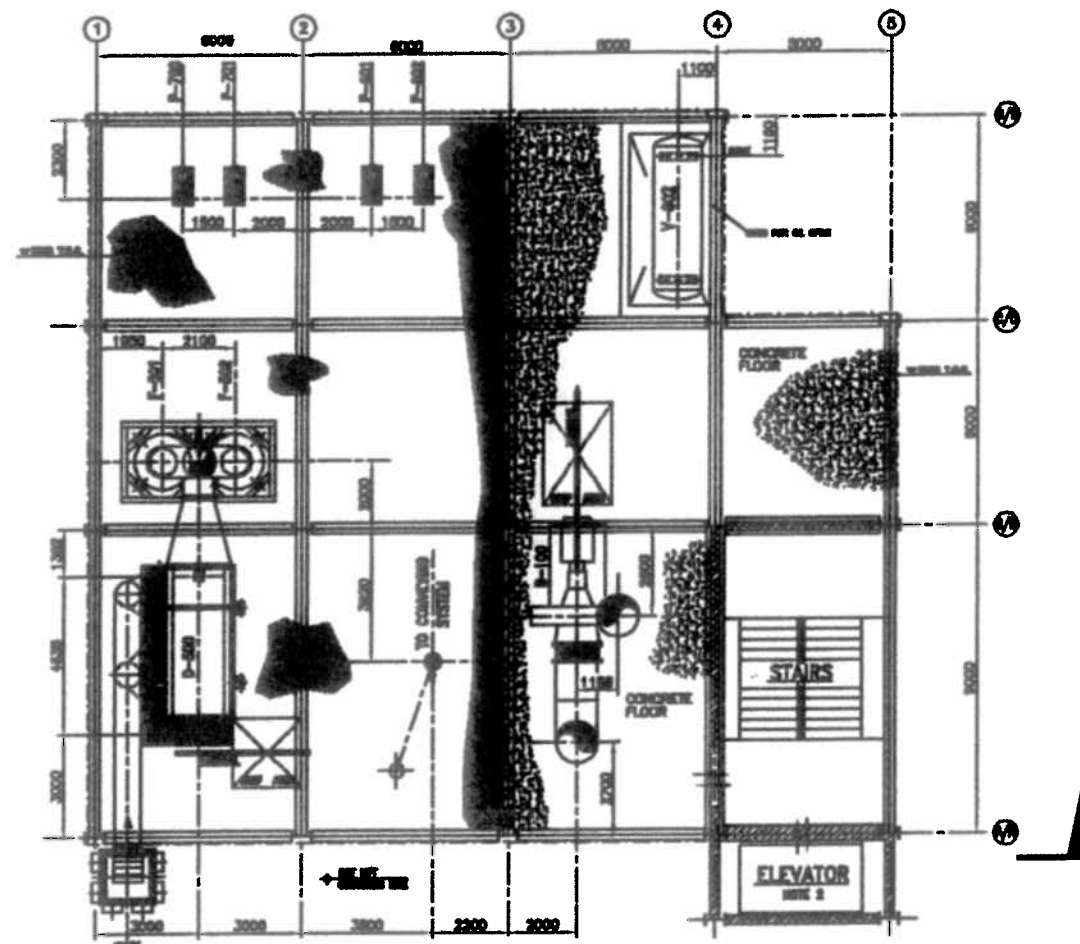
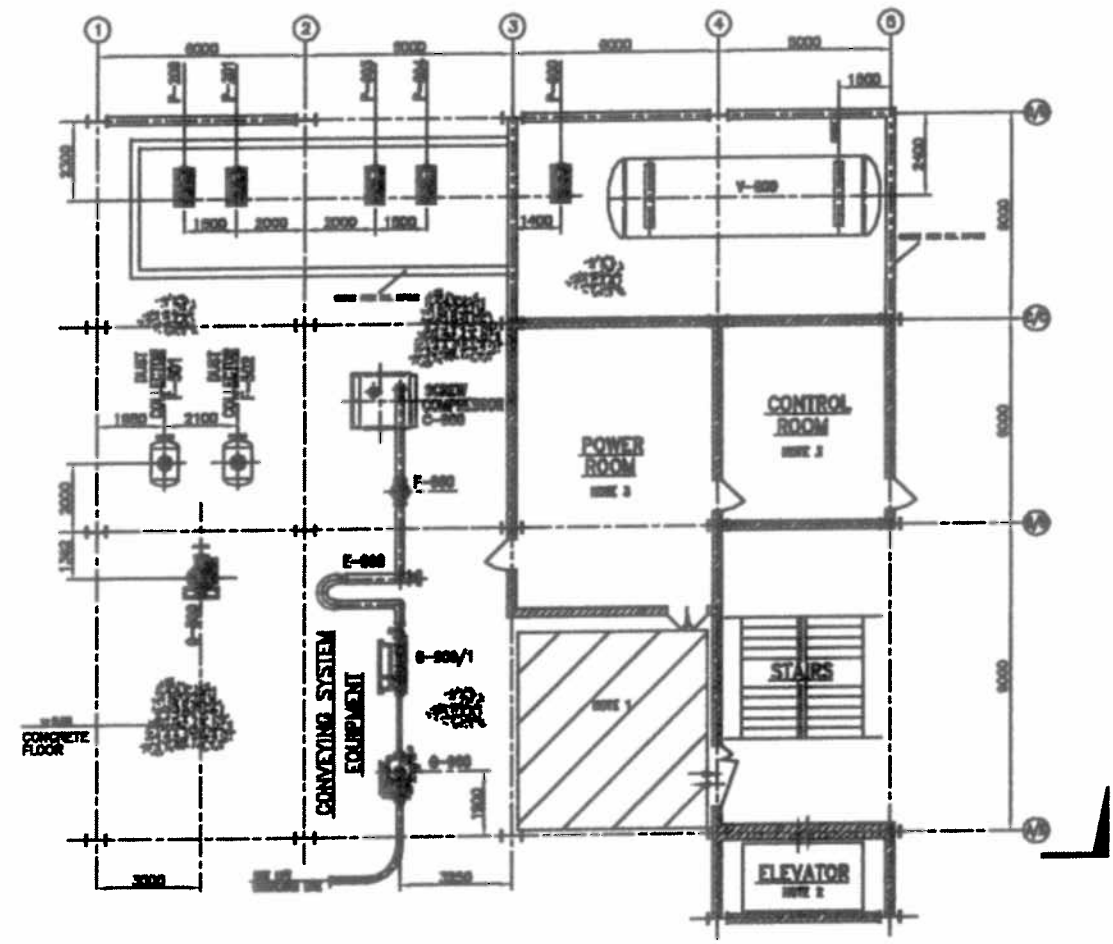


DESIGN IN COMPLIANCE WITH	SP 8000	SL 00000
GENERAL LAYOUT	2000-00-00-00-00-00	
PROPOSED BUILDING LAYOUT PLAN	2-0000-000/00-00-00	
TOP SCALE 1:1000		



PLAN AT ELEV. 5000 T.O.G.



PLAN AT ELEV. 00.00 T.O.G.

SYMBOL	DESCRIPTION
	GRATING (max 30x30 bearing plate 30x)
	WALL
	CORRUGATED STEEL
	CONCRETE FLOOR

HOLDS

- 1) - VOID
- 2) - VOID

GENERAL NOTES

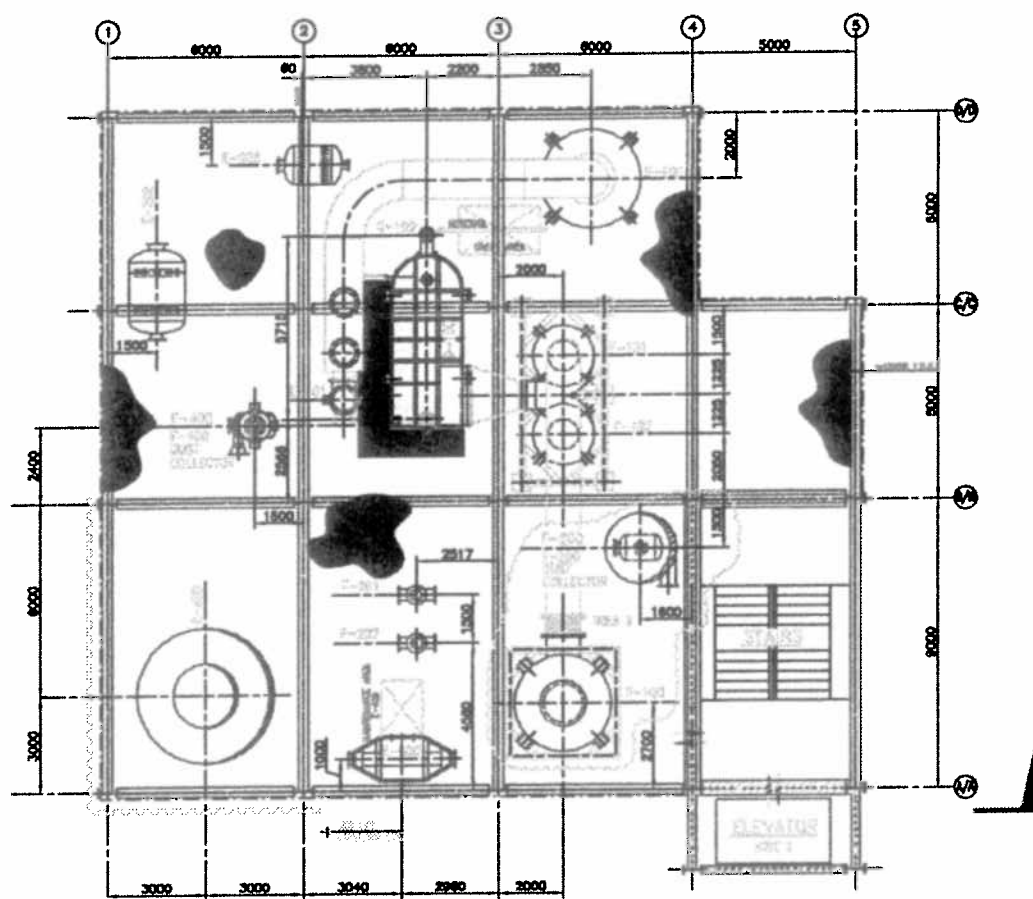
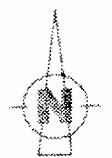
- ALL DIMENSIONS ARE IN mm
- AVERAGE FLOOR LOAD IS 500 kg/m²
- ON SOME POSITIONS, STEEL FRAME SUPPORTING FLOORS MUST BE ABLE TO CARRY LOADS CAUSED BY DISMANTLING HEAVY EQUIPMENT (E.g. motors...)
- STEEL FRAME MUST BE ABLE TO CARRY LOADS CAUSED BY LIFTING BEAMS

NOTES

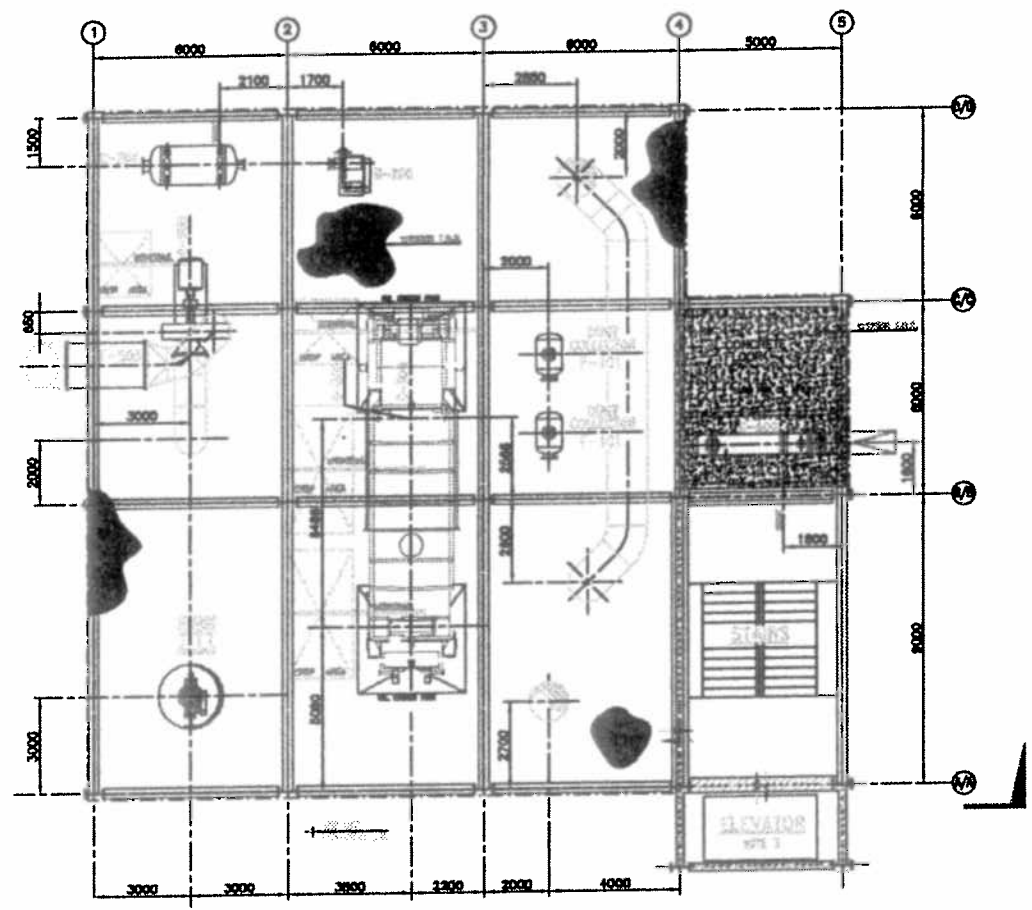
- 1) - DEDICATE AREA FOR TRANSFORMERS (FOR DETAILS SEE DWG. 7322C-EL-00-DW-0020)
- 2) - ELEVATOR DETAILS (SEE DWG. 7322C-ST-00-SL-0010)
- 3) - POWER & CONTROL ROOMS DETAILS (SEE DWG. 7322C-EL-00-DW-0020)

DATE FOR CONSTRUCTION	DATE 12-12-07 BY/AM 12-12-07	BY 12-12-07
DATE FOR CONSTRUCTION	DATE 12-12-07 BY/AM 12-12-07	BY 12-12-07
DESCRIPTION	BY DATE	DATE
	SPP SOLID STATE POLYMERIZATION PLANT	
	SPP ACQUA	
SPP S.p.A.		
7322C		
115	A1	7322C P100GL0001 01

DESIGNER: M. COCKER	NO. COVER	BY: M. COCKER
DATE: 2023-04-10-14-00-00		
PROJECT: PROCESS BUILDING LAYOUT PLANS		
USER: M. COCKER		



PLAN AT LEVEL 12000 L.O.C.



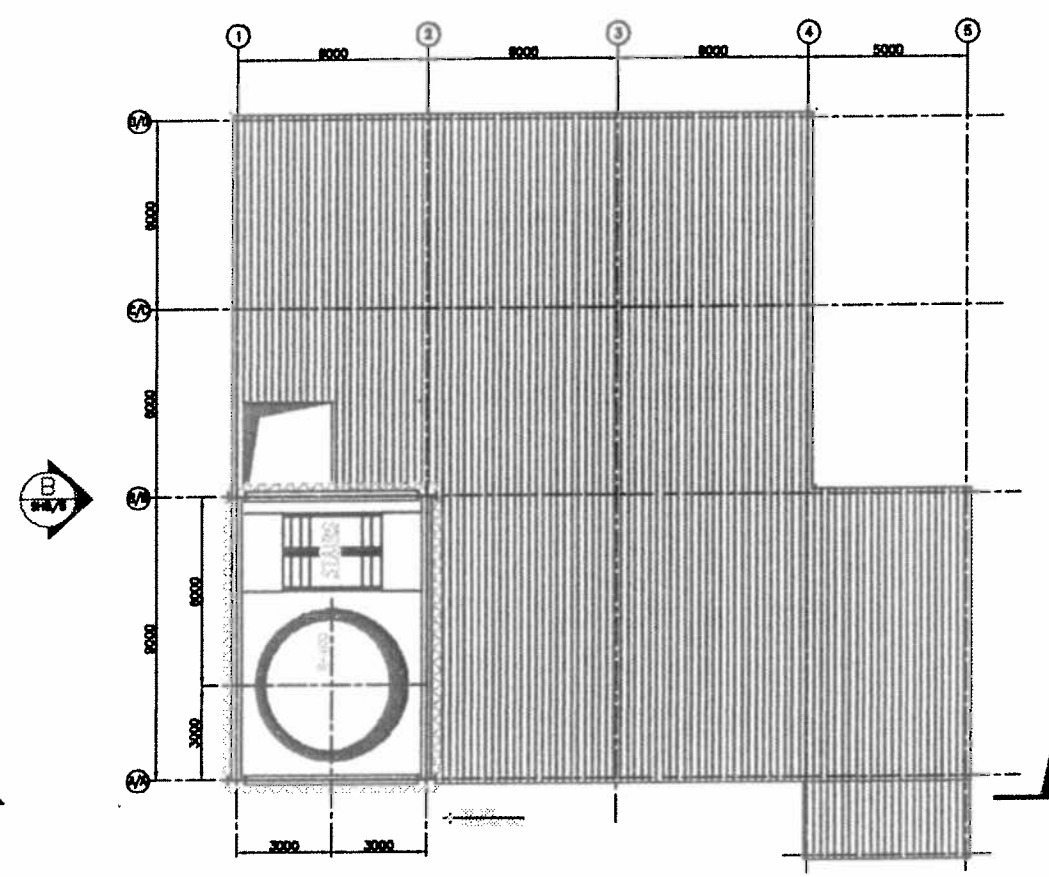
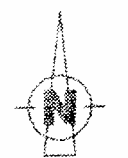
PLAN AT LEVEL 12000 L.O.C.

SYMBOL	DESCRIPTION
	GRATING (from M&E drawing page 270)
	WALL
	CORRUGATED STEEL
	CONCRETE FLOOR

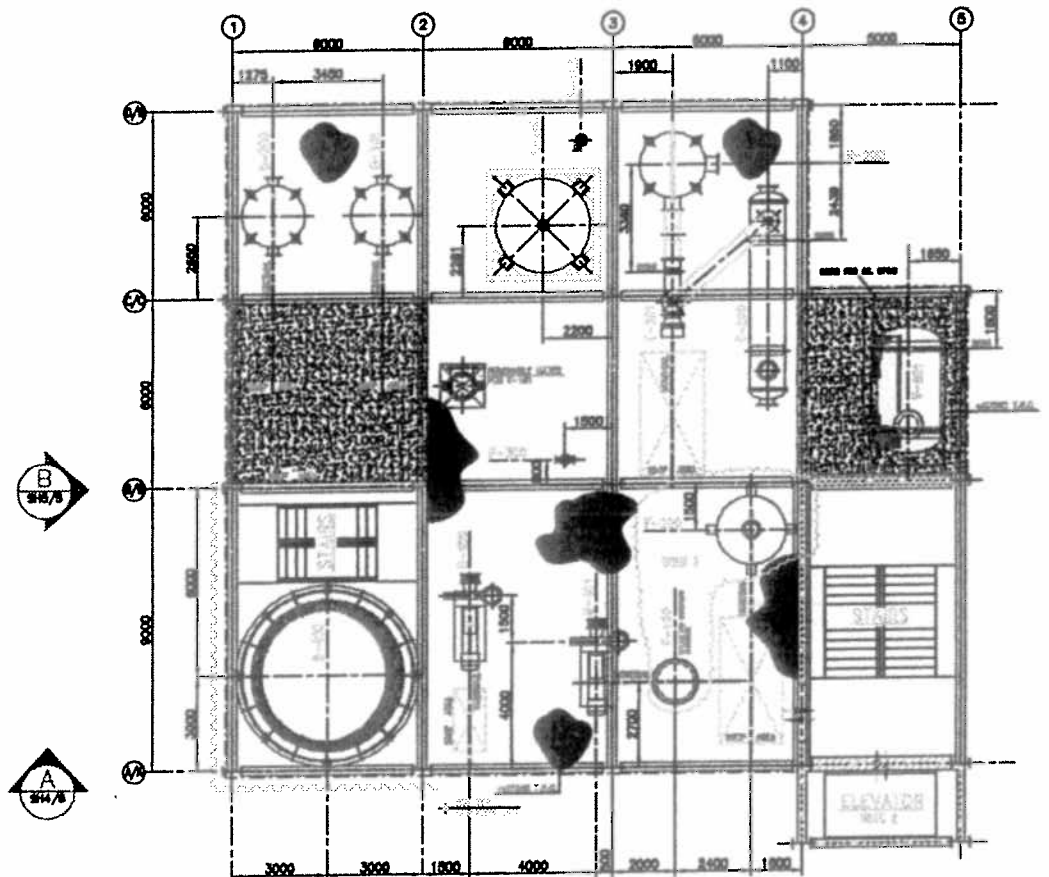
- NOTES:
- 2) - VOID
 - 3) - F-100/F-200 TO BE CONFIRMED WITH SUPPLIER DATA
- NOTES:
- 2) - ELEVATOR DETAILS (SEE DWG. 7322C-ST-00-SL-0010)

DATE OF DESIGN	DATE OF ISSUE	DATE OF REVISION	DATE OF APPROVAL	DATE OF CHECK
2023-04-10	2023-04-10			
BY: M. COCKER	BY: M. COCKER	BY: M. COCKER	BY: M. COCKER	BY: M. COCKER
DESCRIPTION	NO.	DATE	CHK	APP
SSP SOLID STATE POLYMERIZATION PLANT				
SMPE ACCEBA				
PROCESS BUILDING LAYOUT				
Plan from EL. 12000 to EL. 27000				
7322C				
215	A1	7322C	PI00GL0001	01

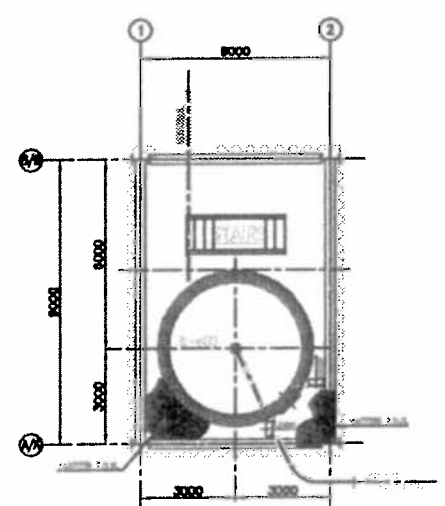
PROJECT: SSP SOLID STATE POLYMERIZATION PLANT
 SYSTEM: PROCESS BUILDING LAYOUT PLANS
 DATE: 04/09/2008
 DRAWING NO: 7322C-PI00GL0001-01
 SHEET NO: 01



PLAN OF LEVEL 2000 I.O.A.



PLAN OF LEVEL 2000 I.O.A.

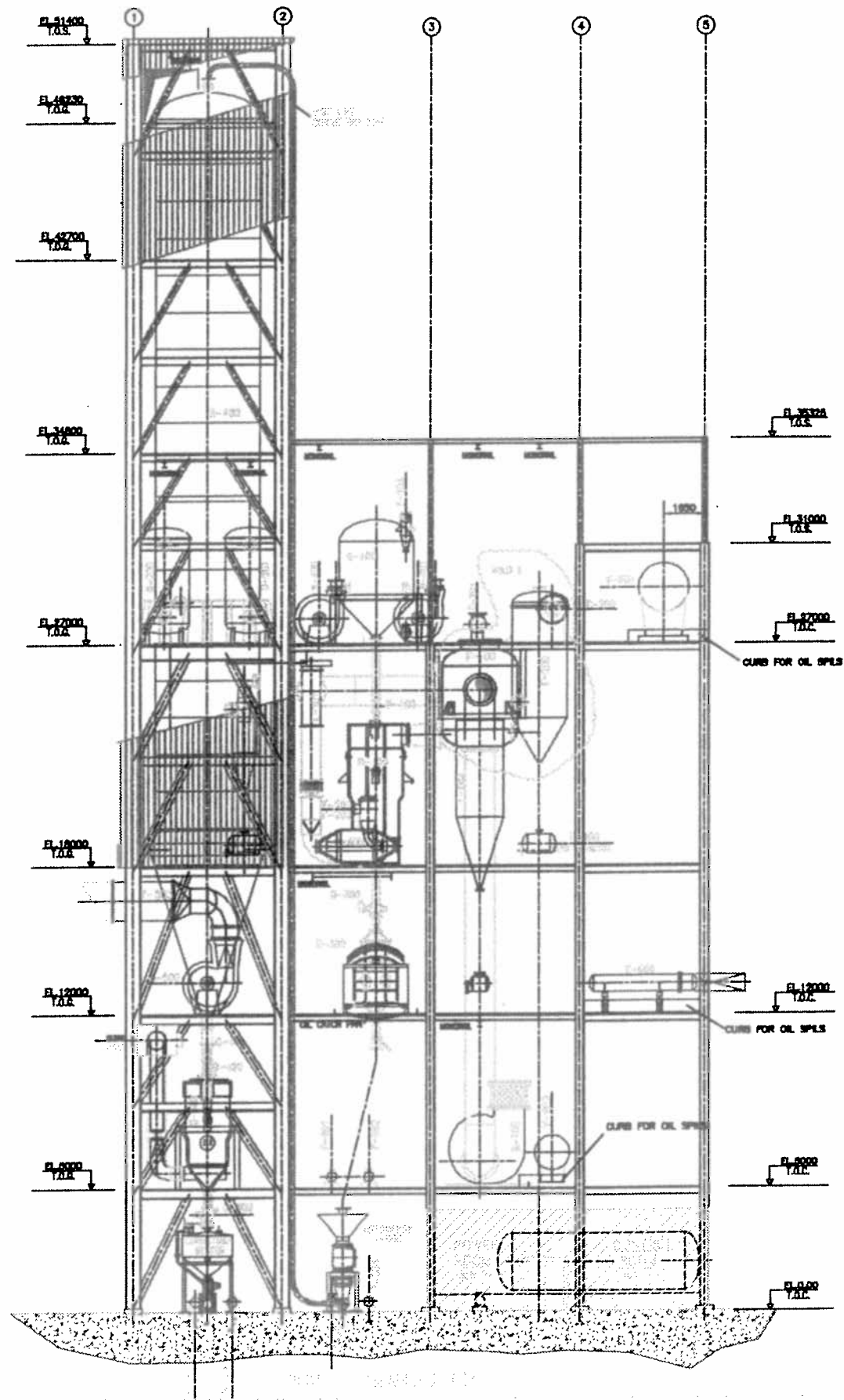


PLAN OF LEVEL 2000 I.O.A.

SYMBOL	DESCRIPTION
	GRATING (width 300, spacing 30x30)
	WALL
	CORRUGATED STEEL
	CONCRETE FLOOR

- NOTES
- VOID
 - F-100/F-200 TO BE CONFIRMED WITH SUPPLIER DATA
 - ELEVATOR DETAILS (SEE DWG. 7322C-ST-00-SL-0010)

 Impian mika	SSP SOLID STATE POLYMERIZATION PLANT PROCESS BUILDING LAYOUT Plan from D. 27000 to D. 31400 SHEET NO. 7322C-PI00GL0001-01	01
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SECTION IN SEVENMETER - SEPTIMETER SEVENMETER
 GENERAL LAYOUT
 PROCESS BUILDING LAYOUT PLAN
 SHEET NO. 7322C-PI00GLO001

SYMBOL	DESCRIPTION
	CRATING (from 2x25 leveling plate 30x3)
	WALL
	CORRUGATED STEEL
	CONCRETE FLOOR

3) - F-100/F-200 TO BE CONFIRMED WITH SUPPLIER DATA
 3) - POWER & CONTROL ROOMS DETAILS (SEE DWG. 7322C-EL-00-DW-0020)

DATE FOR CONSTRUCTION	DATE FOR COMMISSIONING	DATE FOR START-UP	DATE FOR SHUTDOWN
DESCRIPTION	BY	DATE	DATE
SSP SOLID STATE POLYMERIZATION PLANT			
SIMPE ACKEMA			
PROCESS BUILDING LAYOUT			
VIEW A - LOOKING NORTH			
SIMPE S.p.A.			
7322C			
45	A1	7322C	PI00GLO001
			01

